

05-26-2004

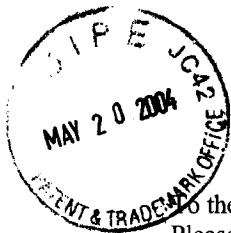
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To the Honorable Commissioner of Patents and Trademarks.
Please record the attached original document or copy thereof.

1. Name of conveying party(ies):
Brad Bivens

2. Name and Address of receiving party(ies):
Name: BH Thermal, Inc.
Internal Address: _____

Additional name(s) of conveying party(ies) attached? Yes No

Street Address: 1055 Gibbard Avenue
Columbus, Ohio 43201

3. Nature of conveyance:
 Assignment Merger
 Security Agreement Change of Name
 Other
Execution Date: May 14, 2004

Additional name(s) & address(es) attached?
 Yes No

4. Application number(s) or patent number(s) 10/733,870

If this document is being filed with a new application, the filing date of the application is:

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? Yes No

5. Name and address of person to whom correspondence concerning document should be mailed:

Name: Belinda L. Reynolds, Legal Assistant
Internal Address: _____
Porter, Wright, Morris & Arthur LLP
Street Address: 41 South High Street

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41):

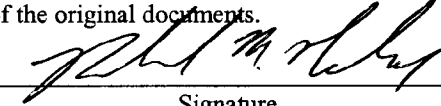
Enclosed
 Authorized to be charged to deposit account

City: Columbus State: OH ZIP: 43215

8. Deposit account number: 16-2326
(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original documents.

Richard M. Mescher  May 18, 2004
Name of Person Signing Signature Date

Total number of pages comprising cover sheet: 1

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Mail documents to be recorded with required cover sheet information to:

Commissioner for Patents
P.O. Box 1450
Arlington, VA 22313-1450

05/25/2004 MBETACHE 00000075 162326 10733870
01 FC:8021 40.00 DA

ASSIGNMENT

Whereas, I, **Brad Bivens**, have solely invented a certain new and original invention for a "**PORTABLE CURING SYSTEM FOR USE WITH VACUUM BAG REPAIRS AND THE LIKE**", for which I submitted U.S. Patent Application Number 10/733,870 on December 11, 2003 (Porter, Wright, Morris & Arthur Docket No. 1505800-050745);

And whereas, **BH Thermal Corporation** a corporation duly organized and existing under the laws of the state of Delaware and having a principle place of business at 1055 Gibbard Avenue, Columbus, Ohio 43201, is desirous of acquiring the entire right, title and interests in, to and under said invention and said patent application, any continuing applications, continuations-in-part, divisional applications, refiled or reissue applications made in the United States of America and all other Nations which may result from said invention and information disclosed in said application, and any and all patents which may be issued therefrom;

Now, therefore, for good and valuable consideration, the receipt of which is hereby acknowledged, I, **Brad Bivens**, do hereby sell, assign and transfer to **BH Thermal Corporation**, the entire right, title and interest, in and to my invention of a "**PORTABLE CURING SYSTEM FOR USE WITH VACUUM BAG REPAIRS AND THE LIKE**", said application for patent, the invention therein described, and all rights appurtenant thereto and in all my applications related thereto, including each of the following: the right to apply for any patent for said invention in the United States of America and in any and all other nations, any and all other applications for patent on said invention including all divisional, renewal, substitute and continuation applications based in whole or in part upon said invention or upon said application or related thereto; any and all patents that may issue thereon in the United States and other Nations and any and all reissues, extensions, renewals, divisions, or continuations of patents granted for said inventions or upon said applications, to the full end of the term or terms for which said patent may be issued; and every priority or other right accorded by every international convention, treaty or agreement that is or may be predicated upon or arise from said invention, application and other applications or patent therefor, all to be held and enjoyed by **BH Thermal Corporation**, its successors and assigns, all the same as I would have held and enjoyed had this Assignment not been made.

I hereby authorize and grant the right to **BH Thermal Corporation**, to file and prosecute patent applications in any or all countries on all or any part of said invention in my name or in the name of **BH Thermal Corporation**, or otherwise, as **BH Thermal Corporation** may deem advisable under any international convention, treaty, or agreement or otherwise.

I hereby request and authorize the Commissioner of Patents and Trademarks of the United States and the empowered officials of all other countries to grant, issue and transfer

any patent for said invention to **BH Thermal Corporation** as assignee of the entire right, title and interests therein, in accordance with this instrument of assignment.

I hereby represent and warrant that there are no outstanding rights or interest inconsistent with the rights and interests granted herein; I covenant that I will not execute, grant, or transfer any rights or interests inconsistent herewith, I bind myself, my heirs, executors, administrators and legal representatives to execute and deliver to **BH Thermal Corporation**, its successors and assigns, any further documents or instruments and to perform any and all acts that may be deemed necessary to enable it, and its successors and assigns, to file patent applications for patents for said invention in any country in which it may elect to file such application, and to vest in **BH Thermal Corporation**, and its successors and assigns, the title herein conveyed and intended to so be, and to enable such title to be recorded in the United States and each Nation in which each such application may be filed so that any patent issued thereon shall be issued to **BH Thermal Corporation**, and its successors and assigns; and I further covenant and agree, for myself and my executors, administrators and legal representatives, that I and they will, upon request, communicate to **BH Thermal Corporation**, and its successors and assigns, any facts relating to said invention and the history thereof, known to me or them and that I and they will testify as to the same in any proceeding, interference or litigation when requested to do so by **BH Thermal Corporation**, and its successors and assigns.

First Inventor:

Brad Bivens

Inventor's Signature:

Brad Bivens

Date Signed:

5/14/04